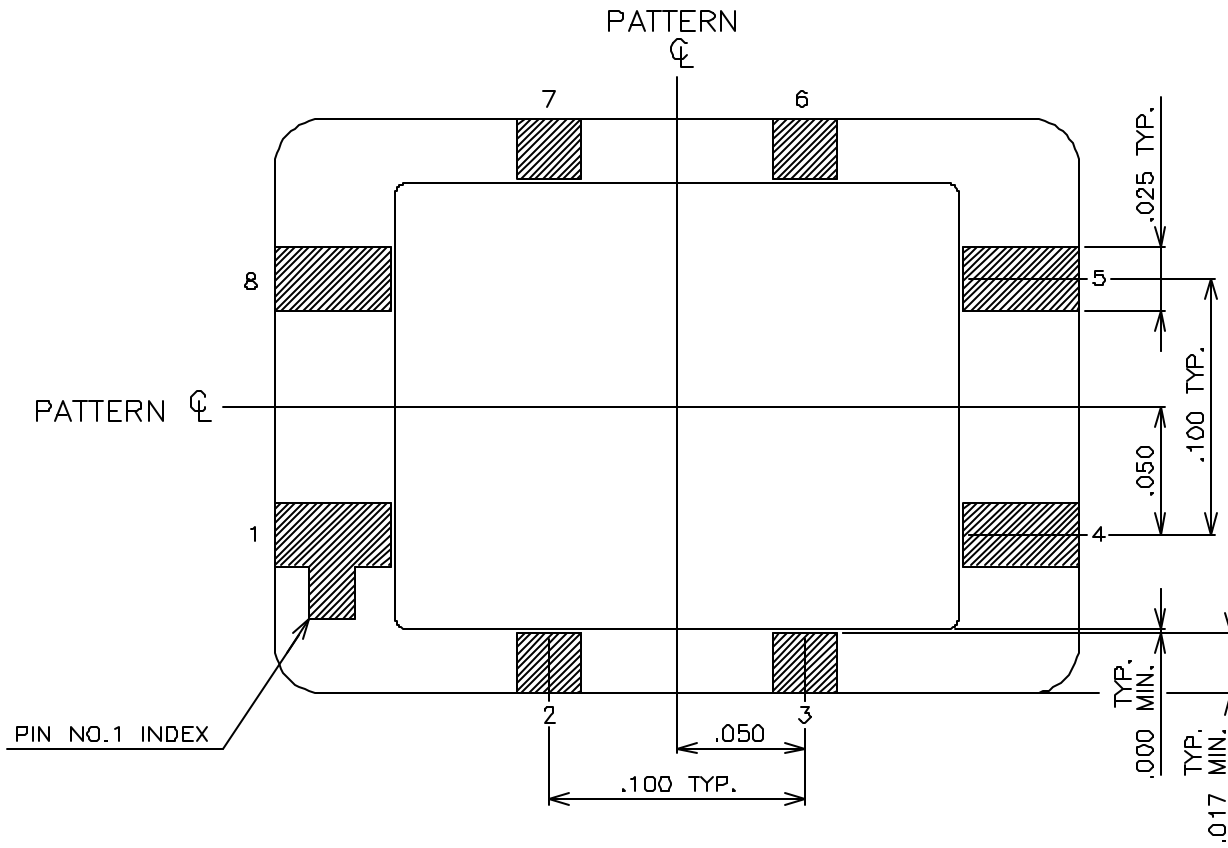


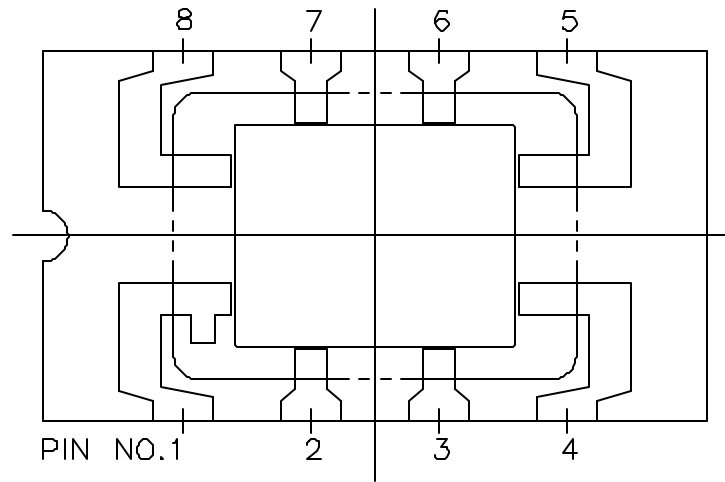
- NOTES:
1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
  2. SEAL AREA TO BE METALLIZED.
  3. DIE ATTACH AREA TO BE METALLIZED.
  4. SEAL RING AND DIE ATTACH PAD TO BE FLOATING FROM ANY PINS.
  5. LEAD RESISTANCE: 0.20 OHM MAX.

MODIFICATION						NAME	8 LEAD SIDE BRAZED PACKAGE	TOLERANCE	±.005	SB008H047-1			S=0
						SCALE	8 / 1	UNLESS OTHERWISE SPECIFIED	TRIPLE ANGLE PROJECTION	DRAWN	CHECKED	APPROVED	DATE
	△	REDRAWN	WR6'96	S.SH	H.S/KJ	T.A	MATERIAL	AS INDICATED		S.SE	H.SU/S.F	T.A	VAR.9'71
	△	CONVERTED CAD DATA	WV20'93	S.SE	H.SU/S.F	T.A							
	CHANGED		DATE	DRAWN	CHECKED	APPROVED	KYOCERA	KYOCERA CORPORATION KYOTO JAPAN		DRAWING NO. KD-77047-F			SHEET 1/3




BONDING PATTERN

MODIFICATION						NAME 8 LEAD SIDE BRAZED PACKAGE	TOLERANCE UNLESS OTHERWISE SPECIFIED	DRAWN S.S.E	CHECKED H.SU/SF	APPROVED T.A	DATE MAR.9.77
	△	REDRAWN	MAR.8.96	S.SH	H.S/KJ	T.A	SCALE 20 / 1	MATERIAL			
	△	CONVERTED CAD DATA	MAY.20.93	S.S.E	H.SU/SF	T.A					
		CHANGED		DATE	DRAWN	CHECKED	APPROVED				
							FINISH ANGLE PROJECTION	DRAWING NO. KD-77047-F			SHEET 2/3
							KYOCERA	KYOCERA CORPORATION KYOTO JAPAN			



MP-2

MODIFICATION						NAME	TOLERANCE	DRAWN	CHECKED	APPROVED	DATE
						8 LEAD SIDE BRAZED PACKAGE	UNLESS OTHERWISE SPECIFIED	S.SE	H.SJ/S.F	T.A	NOV.11'82
	△	REDRAWN	WRB'86	S.SH	H.S/KJ	T.A	SCALE 10 / 1	MATERIAL			
	△	CONVERTED CAD DATA	WV'20'93	S.SE	H.SJ/S.F	T.A					
	CHANGED	DATE	DRAWN	CHECKED	APPROVED		KYOCERA CORPORATION KYOTO JAPAN	DRAWING NO.		SHEET	
								KD-77047-F		3 / 3	